

 **VIEW CART**

Part: IRFC23N15B

Description: 150V Gen 5.3 HEXFET DIE ON WAFER

Support Docs: [Datasheet](#)

Specifications	
Parameter	Value
Product Family	HEXFET
Package	DIE ON WAFER
Package Equivalent	IRFB23N15D
Gen	5.3
Voltage	150
Die Product	DieProduct


Packaging Options						
Product ID	Description	Status	Standard Pack	1 K Budgetary Pricing (USD)	Qty	
IRFC23N15B	150V Gen 5.3 HEXFET DIE ON WAFER	Active			1	ADD TO CART

Package Support Docs

IR can offer a range of carrier options to suit individual customer needs. As standard, we offer probed Die on wafer, sawn Die on film and in waffle tray / chip pack.

For certain Die products, Tape and Reel, in the form of Pocket Tape is available. Please use our online help utility for details.

Details on the advantages/disadvantages of the various carrier options can be found in the application note on carrier options or the links above.



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